

Satoshi Shindo

List of Publications by Year in descending order

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#	ARTICLE	IF	CITATIONS
1	Observation of ultrafast amorphization dynamics in GeCu ₂ Te ₃ thin films using echelon-based single-shot transient absorbance spectroscopy. <i>Applied Physics Letters</i> , 2021, 119, .	3.3	3
2	The importance of contacts in Cu ₂ GeTe ₃ phase change memory devices. <i>Journal of Applied Physics</i> , 2020, 128, .	2.5	11
3	Cr-Triggered Local Structural Change in Cr ₂ Ge ₂ Te ₆ -Based Phase Change Material. <i>ACS Applied Materials & Interfaces</i> , 2019, 11, 43320-43329.	8.0	26
4	Systematic materials design for phase-change memory with small density changes for high-endurance non-volatile memory applications. <i>Applied Physics Express</i> , 2019, 12, 051008.	2.4	7
5	Inverse Resistance Change Cr ₂ Ge ₂ Te ₆ -Based PCRAM Enabling Ultralow-Energy Amorphization. <i>ACS Applied Materials & Interfaces</i> , 2018, 10, 2725-2734.	8.0	85
6	Understanding the fast phase-change mechanism of tetrahedrally bonded Cu ₂ Ge ₂ Te ₆ : Comprehensive analyses of electronic structure and transport phenomena. <i>Physical Review B</i> , 2018, 97, .	3.2	11
7	Investigation of bias polarity dependence of set operation in GeCu ₂ Te ₃ phase change memory. <i>Electronics Letters</i> , 2018, 54, 350-351.	1.0	2
8	Contact resistance change memory using N-doped Cr ₂ Ge ₂ Te ₆ phase-change material showing non-bulk resistance change. <i>Applied Physics Letters</i> , 2018, 112, .	3.3	28
9	Molybdenum oxide-base phase change resistive switching material. <i>Applied Physics Letters</i> , 2017, 111, .	3.3	8
10	Electronic Structure of Transition-Metal Based Cu ₂ GeTe ₃ Phase Change Material: Revealing the Key Role of Cu d Electrons. <i>Chemistry of Materials</i> , 2017, 29, 7440-7449.	6.7	24
11	Implementation of pulse timing discriminator functionality into a GeSbTe/GeCuTe double layer structure. <i>Optics Express</i> , 2017, 25, 26825.	3.4	1
12	Effect of surface cleaning on contact resistivity of amorphous GeCu ₂ Te ₃ to a W electrode. <i>MRS Advances</i> , 2016, 1, 2731-2736.	0.9	2
13	Impact of contact resistance on memory window in phase-change random access memory (PCRAM). <i>Journal of Computational Electronics</i> , 2016, 15, 1570-1576.	2.5	3
14	Contact resistivity of amorphous and crystalline GeCu ₂ Te ₃ to W electrode for phase change random access memory. <i>Materials Science in Semiconductor Processing</i> , 2016, 47, 1-6.	4.0	24
15	XAFS Analysis of Crystal GeCu ₂ Te ₃ Phase Change Material. <i>Zeitschrift Fur Physikalische Chemie</i> , 2016, 230, 433-443.	2.8	4
16	Electrical Contact Property of GeCu ₂ Te ₃ Phase Change Material to Electrode. <i>ECS Meeting Abstracts</i> , 2016, .	0.0	0
17	(Invited) Ge-Cu-Te Phase Change Material for Pcram Application. <i>ECS Meeting Abstracts</i> , 2016, .	0.0	0
18	Chronological change of electrical resistance in GeCu ₂ Te ₃ amorphous film induced by surface oxidation. <i>Journal Physics D: Applied Physics</i> , 2014, 47, 475302.	2.8	7